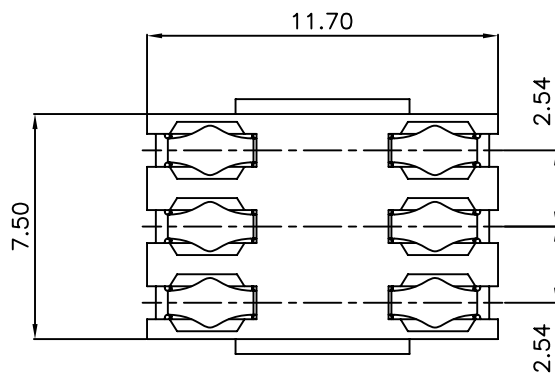
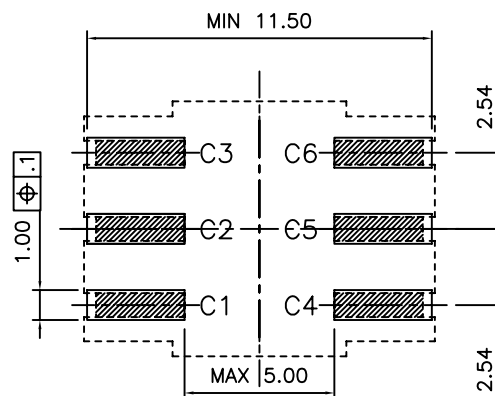
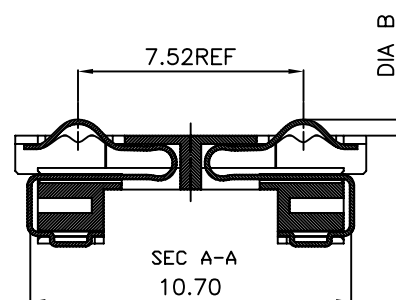
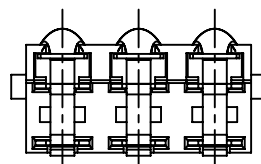
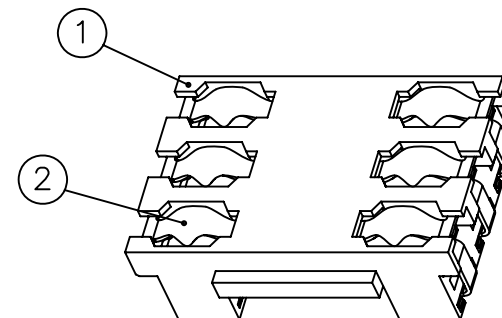


P/N	DIM A	DIM B
M30-XXXX-XXXXX	4.10 ^{+0.09} _{-0.04}	0.50 ^{+0.15} _{-0.06}
M30-XXXX-XXXXX	3.90±0.10	0.50±0.15
M30-0728-00002	3.70±0.10	0.50±0.15
M30-XXXX-XXXXX	3.50±0.10	0.50±0.15
M30-XXXX-XXXXX	3.30±0.10	0.50±0.15
M30-XXXX-XXXXX	3.10±0.10	0.50±0.15
M30-XXXX-XXXXX	2.90±0.10	0.50±0.15
M30-XXXX-XXXXX	2.70±0.10	0.50±0.15
M30-XXXX-XXXXX	2.50±0.10	0.50±0.15
M30-XXXX-XXXXX	2.30±0.10	0.50±0.15



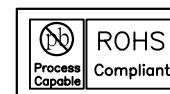
RECOMMENDED PCB MOUNTING PATTERN

ITEM 項目	PARTS NAME 零件名稱	Q'TY 數量	MATERIAL 材質	FINISH/REMARK 處理/備註
1	HOUSING	1	LCP	(Black)
2	CONTACT	6	Phosphor Bronze	Base : Ni:50u" Min Contact area : 5u" gold plating 1~3u" gold flash over all



SPECIFICATION
MATERIAL
See drawing
STANDARD DATA
Rating current:1.0A
Applicable wire: AWG#26 Max.
Operating temperature: -25°C ~ +70°C
Storage temperature: -40°C ~ +85°C
ELECTRICAL
Insulator resistance: 500M ohms Min. @ 100 VDC
Withstanding voltage: 500 VAC / minute
Contact resistance: 50 m ohms Max.
MECHANICAL
Mating force: 30N(3.06kgf) Max.
Unmating force (Without lock): 0.4N(0.04kgf) Min.
Durability: 5000 cycles Min.
Contact retention force: 0.4N(0.04kgf) Min

PART NO. E 0 3 - 0728 - 06 002
SERIES A=SIM CARD
TYPE 2=OTHER TYPE
CONTACT TYPE 3=SMD TYPE
MODEL NO. 0728
TYPE NO. 002=TYPE 2
CONTACT NUMBER 06=06 position



REV. 版本	ECN NO. 設變號碼	MARK 記號	REVISIONS 設變內容	SIGN 修改	DATE 日期	UNLESS OTHERWISE SPECIFIED TOLERANCE 尺寸公差	CHECKED 審核	DESIGNED 設計	DRAWN 製圖	TITLE 產品名稱	PART NO. 產品料號	DOC. NO. 文件編號	REV. 版本
A	E0806-005	△ X 0	新增	Brian	08/22/08'	X. ±0.50 .X ±0.30 .XX ±0.20 ANG. ±5°00'		08/22/08'	Brian	6 PIN SIM CARD	E03-0728-06002	CUT-0728-003	1/2 A

